

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









STGW80H65FB-4

Trench gate field-stop IGBT, HB series 650 V, 80 A high speed in TO247-4 package

Datasheet - production data

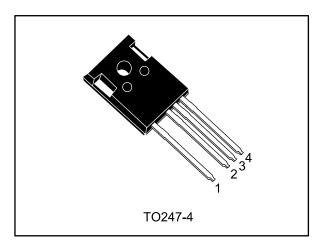
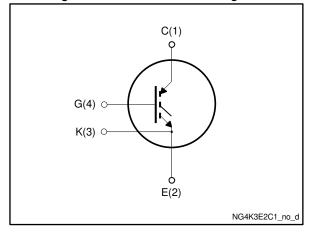


Figure 1: Internal schematic diagram



Features

- $V_{CE(sat)} = 1.6 \text{ V (typ.)} @ I_{C} = 80 \text{ A}$
- Maximum junction temperature: T_J = 175 °C
- High speed switching series
- Minimized tail current
- Safe paralleling
- Tight parameter distribution
- Low thermal resistance
- Kelvin pin

Applications

- Photovoltaic inverter
- High frequency converter

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the new HB series of IGBTs, which represents an optimum compromise between conduction and switching loss to maximize the efficiency of any frequency converter. Furthermore, the slightly positive V_{CE(sat)} temperature coefficient and very tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

Order code	Marking	Package	Packaging
STGW80H65FB-4	G80H65FB	TO247-4	Tube

Contents STGW80H65FB-4

Contents

1	Electric	eal ratings	3
2	Electric	cal characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	10
4	Packag	e information	11
	4.1	TO247-4 package information	11
5	Revisio	n history	13

STGW80H65FB-4 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter		Unit	
Vces	Collector-emitter voltage (V _{GE} = 0 V)	650	٧	
1-	Continuous collector current at T _C = 25 °C 120 ⁽¹⁾		۸	
lc	Continuous collector current at T _C = 100 °C	80	Α	
ICP ⁽²⁾⁽³⁾	Pulsed collector current	300	Α	
V_{GE}	Gate-emitter voltage	±20	V	
Ртот	Total dissipation at T _C = 25 °C	469	W	
T _{STG}	Storage temperature range	-55 to 150	°C	
TJ	Operating junction temperature range	-55 to 175		

Notes:

Table 3: Thermal data

Symbol	Parameter Value		Unit
RthJC	Thermal resistance junction-case	0.32	°C/W
RthJA	R _{thJA} Thermal resistance junction-ambient 50		-0/00

⁽¹⁾Current level is limited by bond wires.

 $^{^{(2)}} Pulse$ width is limited by maximum junction temperature (tp < 1 ms, TJ < 175 °C).

 $[\]ensuremath{^{(3)}}\mbox{Defined}$ by design, not tested.

Electrical characteristics STGW80H65FB-4

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 4: Static characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage	$V_{GE} = 0 \text{ V}, I_C = 2 \text{ mA}$	650			٧
V _{CE(sat)} Collector-emitter saturation voltage		$V_{GE} = 15 \text{ V}, I_{C} = 80 \text{ A}$		1.6	2.0	
		V _{GE} = 15 V, I _C = 80 A, T _J = 125 °C		1.8		٧
	V _{GE} = 15 V, I _C = 80 A, T _J = 175 °C		1.9			
V _{GE(th)}	Gate threshold voltage	V _{CE} = V _{GE} , I _C = 1 mA	5	6	7	V
I _{CES}	Collector cut-off current	$V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}$			100	μΑ
Iges	Gate-emitter leakage current	Vce = 0 V, Vge = ±20 V			±250	nA

Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		1	10.5	1	
Coes	Output capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GE} = 0 \text{ V}$	1	0.38	1	nF
Cres	Reverse transfer capacitance	Val - 0 V	ı	0.21	1	
Qg	Total gate charge	$V_{CC} = 520 \text{ V}, I_C = 80 \text{ A},$	1	414	1	
Qge	Gate-emitter charge	V _{GE} = 0 to 15 V (see <i>Figure 23: "Gate</i>	1	78	1	nC
Q_{gc}	Gate-collector charge	charge test circuit")	-	170	-	

Table 6: IGBT switching characteristics (inductive load)

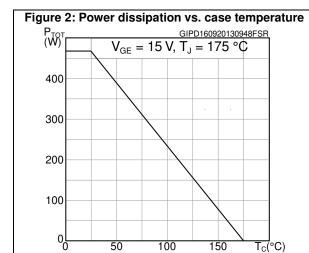
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	75	-	ns
tr	Current rise time		-	35	-	ns
(di/dt) _{on}	Turn-on current slope	V _{CE} = 400 V, I _C = 80 A,	-	1750	-	A/μs
t _{d(off)}	Turn-off-delay time	$V_{GE} = 15 \text{ V}, R_G = 10 \Omega$	-	336	-	ns
t _f	Current fall time	(see Figure 22: "Test circuit for inductive load	-	23	-	ns
E _{on} (1)	Turn-on switching energy	switching")	-	1	-	mJ
E _{off} (2)	Turn-off switching energy		-	1.7	-	mJ
Ets	Total switching energy		-	2.7	-	mJ
t _{d(on)}	Turn-on delay time		-	66	-	ns
tr	Current rise time		-	38	-	ns
(di/dt) _{on}	Turn-on current slope	$V_{CE} = 400 \text{ V}, I_{C} = 80 \text{ A},$ $V_{GE} = 15 \text{ V}, R_{G} = 10 \Omega,$	-	1670	-	A/μs
t _{d(off)}	Turn-off-delay time	$T_J = 175 ^{\circ}\text{C}$	-	403	-	ns
tf	Current fall time	(see Figure 22: "Test	-	45	-	ns
E _{on} (1)	Turn-on switching energy	circuit for inductive load switching")		1.5	-	mJ
E _{off} (2)	Turn-off switching energy	,	-	2.47	-	mJ
E _{ts}	Total switching energy		-	3.97	-	mJ

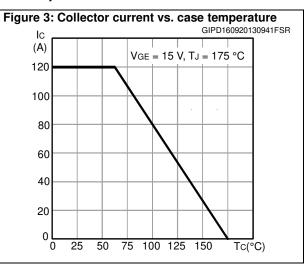
Notes:

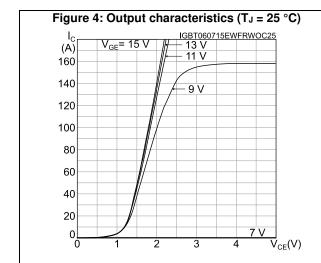
 $^{^{(1)} \}mbox{lncluding the reverse recovery of the external diode. The diode is the same of the co-packed STGW80H65DFB-4.$

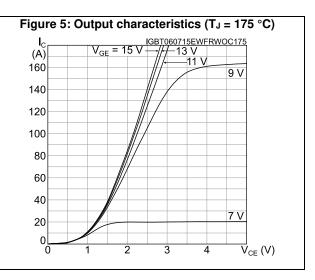
 $[\]ensuremath{^{(2)}}\mbox{Including}$ the tail of the collector current.

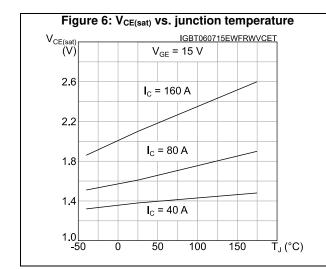
2.1 Electrical characteristics (curves)











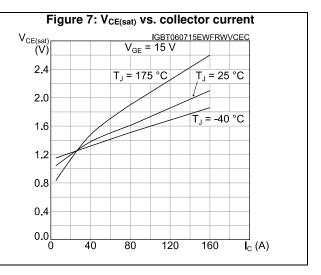
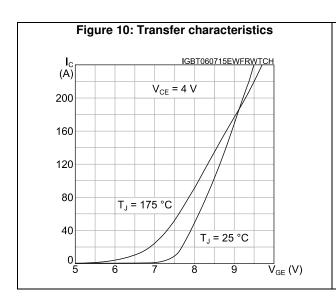
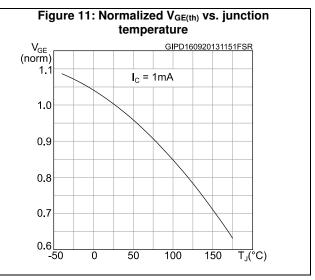
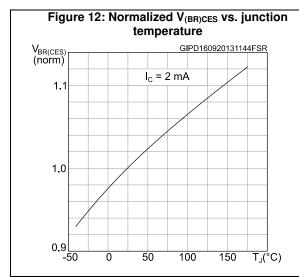


Figure 8: Collector current vs. switching frequency IGBT060715EWFRWCCS 160 140 120 100 T_C= 100 °C T_C= 80 °C 80 60 40 Rectangular current shape (duty cycle = 0.5, V_{CC} = 400 V, R_{G} = 10 Ω , V_{GE} = 0/15 V, T_{J} = 175 °C) 20 0 10¹ f (kHz) 10² 10°

Figure 9: Forward bias safe operating area I_{C} (A) I_{D} I_{D}







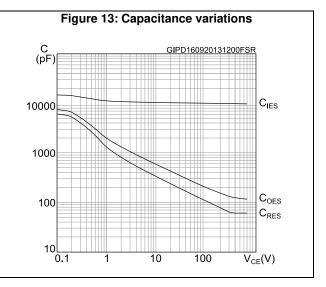


Figure 14: Gate charge vs. gate-emitter voltage

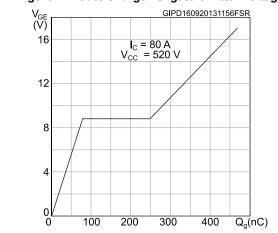


Figure 15: Switching energy vs. collector current

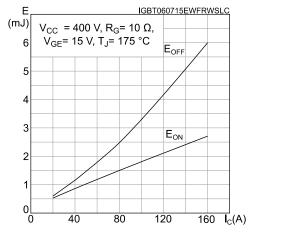


Figure 16: Switching energy vs. gate resistance

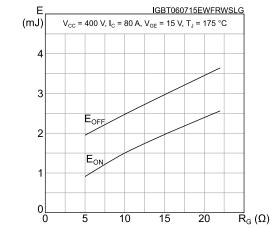


Figure 17: Switching energy vs. temperature

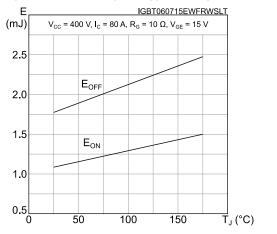


Figure 18: Switching energy vs. collector emitter voltage

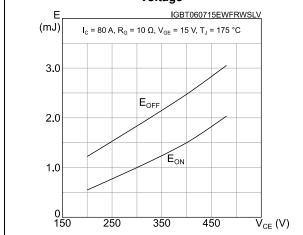


Figure 19: Switching times vs. collector current

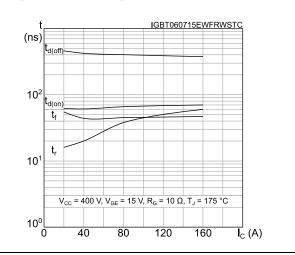
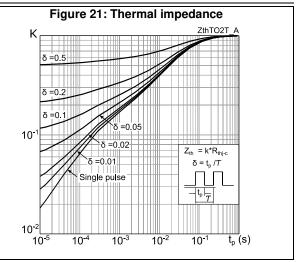
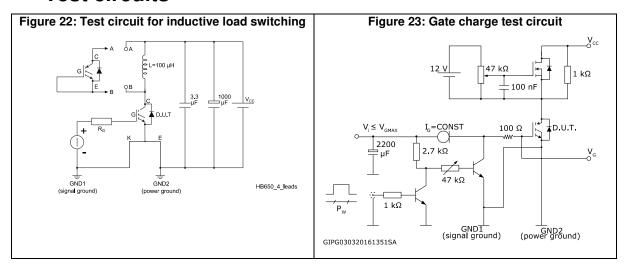


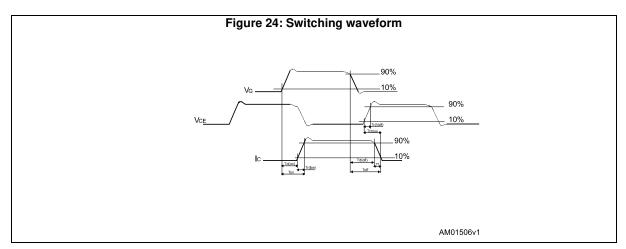
Figure 20: Switching times vs. gate resistance $t_{(ns)}$ $t_{d(off)}$ $t_{d(off)}$ t_{f} t_{r} $V_{cc} = 400 \text{ V, } V_{GE} = 15 \text{ V, } I_{c} = 80 \text{ A, } T_{J} = 175 \text{ °C}$ $0 \quad 5 \quad 10 \quad 15 \quad 20 \quad R_{G} \left(\Omega\right)$



Test circuits STGW80H65FB-4

3 Test circuits





4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO247-4 package information

øP1 Α2 \Box D3 øP2 Α1 b2 b (x4) e (x2) SECTION A-A BASE METAL WITH PLATING b1 8405626_A

Figure 25: TO247-4 package outline

Table 7: TO247-4 mechanical data

Table 7: 10247-4 mechanical data					
Dim.		mm			
	Min.	Тур.	Max.		
Α	4.90	5.00	5.10		
A1	2.31	2.41	2.51		
A2	1.90	2.00	2.10		
b	1.16		1.29		
b1	1.15	1.20	1.25		
b2	0		0.20		
С	0.59		0.66		
c1	0.58	0.60	0.62		
D	20.90	21.00	21.10		
D1	16.25	16.55	16.85		
D2	1.05	1.20	1.35		
D3	24.97	25.12	25.27		
Е	15.70	15.80	15.90		
E1	13.10	13.30	13.50		
E2	4.90	5.00	5.10		
E3	2.40	2.50	2.60		
е	2.44	2.54	2.64		
e1	4.98	5.08	5.18		
L	19.80	19.92	20.10		
Р	3.50	3.60	3.70		
P1			7.40		
P2	2.40	2.50	2.60		
Q	5.60		6.00		
S		6.15			
Т	9.80		10.20		
U	6.00		6.40		

STGW80H65FB-4 Revision history

5 Revision history

Table 8: Document revision history

Date	Revision	Changes
13-Apr-2016	1	First release
22-Apr-2016	2	Minor text changes to improve the document readability
03-Apr-2017	3	Updated title and features on cover page. Updated Table 2: "Absolute maximum ratings". Updated Figure 9: "Forward bias safe operating area". Minor text changes

IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics - All rights reserved